

Large-scale graphitic thin films synthesized on Ni and transferred to insulators: Structural and electronic properties

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We present a comprehensive study of the structural and electronic properties of ultrathin films containing graphene layers synthesized by chemical vapor deposition based surface segregation on polycrystalline Ni foils then transferred onto insulating SiO₂/Si substrates. Films of size up to several mm's have been synthesized. Structural characterizations by atomic force microscopy, scanning tunneling microscopy, *cross-sectional* transmission electron microscopy (XTEM), and Raman spectroscopy confirm that such large-scale graphitic thin films (GTF) contain both thick graphite regions and thin regions of few-layer graphene. The films also contain many wrinkles, with sharply-bent tips and dislocations revealed by XTEM, yielding insights on the growth and buckling processes of the GTF. Measurements on mm-scale back-gated transistor devices fabricated from the transferred GTF show ambipolar field effect with resistance modulation $\sim 50\%$ and carrier mobilities reaching ~ 2000 cm²/V s. We also demonstrate quantum transport of carriers with phase coherence length over 0.2 μ m from the observation of two-dimensional weak localization in low temperature magnetotransport measurements. Our results show that despite the nonuniformity and surface roughness, such large-scale, flexible thin films can have electronic properties promising for device applications. © 2010 American Institute of Physics. [doi:10.1063/1.3309018]

Graphene has attracted tremendous interest for its potential to enable new carbon-based nanoelectronics and other nanotechnology applications.¹ Numerous methods have been developed for the production of graphene and graphene-based materials.^{1–4} While the study of *electrically isolated* graphene was quite recent,^{1,2} graphene has been synthesized by chemical vapor deposition (CVD) and surface segregation on various transition metals and other conducting substrates for several decades.⁵ One of the most commonly used substrates has been Ni and graphene layers (down to monolayer) grown on Ni have been extensively studied.^{5,6} On the other hand, it was only very recently that such graphene layers were transferred (by removing the Ni substrates) to insulating substrates,^{7–10} enabling electronic applications. This renewed interest in graphene growth on Ni has also been driven by the promise for large-scale production of graphene.^{4,7–10} While high quality monolayer graphene can be grown *locally* on Ni,^{7–10} over large areas, however, the films grown on Ni demonstrated so far^{7–12} generally have

nonuniform thickness and surface roughness (e.g., wrinkles) as a result of the growth process.^{7–12} A good understanding of the electronic properties of such large scale graphitic thin films (GTF) in the presence of structural nonuniformity and roughness is important for their applications as flexible and transparent electronic materials. This may also be relevant for graphene-based materials synthesized by many other methods^{2,3} (e.g., numerous solution-based chemical approaches^{13–16}) which often give large but nonuniform GTF made of connected regions containing different number of graphene layers. In addition, many structural features or defects, such as wrinkles, need to be better understood on a microscopic level in order to clarify how they are formed and how they may affect the mechanical as well as electronic properties of the large-scale films.^{9,11,12}

In a previous publication (Ref. 7), we reported synthesis of high quality, transferrable graphene layers using a CVD-based segregation approach on polycrystalline Ni foils. In this paper, we present a comprehensive study of the structural and electronic properties of thus-synthesized *large-scale* GTF after transfer onto insulating substrates (SiO₂/Si). We performed various structural characterizations to examine the crystalline quality of the transferred films and con-

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FIG. 1. (Color) Transfer of large-scale GTF to insulator substrate. (a) Photograph of a large-size film floating on the surface of the acid solution (HNO_3) used to etch the film off its growth substrate (nickel). A pair of tweezers is placed behind the largely-transparent film. (b) Photograph of the film in (a) transferred onto a SiO_2/Si wafer. (c) Optical microscope image of a transferred film. The color variation, related to thickness nonuniformity, and the wrinkles on the film are clearly visible (the scale bar is $15 \mu\text{m}$). A relatively thick film is shown in (a)–(c) for better visibility.

firmed the thickness nonuniformity and presence of surface roughness (e.g., wrinkles). A *cross-sectional* transmission electron microscopy (XTEM) analysis was used to examine how the transferred graphene layers relate to the underlying substrate and how wrinkles may have formed by buckling of the thin film. We performed various electronic and magnetotransport measurements in *large* (mm-scale) samples. We observed ambipolar field effect and carrier mobilities over $\sim 2000 \text{ cm}^2/\text{V s}$. We also observed “weak localization” (WL) and extracted information on the scattering and quantum coherent transport of carriers. Our results show that despite the structural irregularities, our large-scale graphitic films can have excellent electronic properties for potential devices applications.

Our method to grow graphene layers on low-cost, commercially available polycrystalline nickel (Ni) foils has been described in detail previously⁷ (see also Appendix). The growth is predominantly a nonequilibrium surface segregation process by controlled cooling, conducted in an *ambient-pressure* CVD furnace, and is qualitatively similar to other recent studies using evaporated Ni films as growth substrates.^{8–10} Our previous studies⁷ have shown that one to multiple layers of graphene of high quality can be grown by such a method and transferred to other substrates. The number of graphene layers grown is found to depend sensitively on many experimental parameters, including the pressure and composition of the precursor gas, growth time, substrate temperature, cooling rate, and so on.^{5,7–12} As a result, the thickness of the film is generally nonuniform at large scale.^{7–12} In our case, we can often find regions as thin as a few (<6) layers of graphene⁷ and as thick as tens of layers in the same sample. Transferring as-grown GTF from metals to insulator substrates is a critical step for fabricating electronic devices. For the current work, we have used a simple method of substrate transfer (differently from what we used in Ref. 7), without the need of any auxiliary adhesive or supportive coatings.^{7–10} The Ni substrate with as-grown films is placed in an acid solution, where the GTF detaches from the Ni and floats on top of the liquid surface. This is demonstrated in Fig. 1(a) for a large film, close to 1 cm in size and largely transparent. The film can then be simply skimmed out by the insulator substrate onto which it is transferred [Fig. 1(b)]. The type of insulator substrate used in this work is 300 nm SiO_2 thermally-grown on a doped Si wafer. Figure 1(c) shows an optical microscope image of a synthesized GTF

transferred to such a SiO_2/Si substrate. We can clearly see both the color variation (related to the thickness nonuniformity^{17,18}) and the wrinkles/ridges on the film.

Results of structural characterizations using several different experimental tools of our synthesized GTF after transferring onto SiO_2/Si are summarized in Fig. 2. Figure 2(a) shows an atomic force microscopy (AFM) image near the edge of a transferred GTF and Fig. 2(b) shows the cross-sectional height profile corresponding to the line in Fig. 2(a). The step from the SiO_2 surface to the GTF here has a height $< \sim 1 \text{ nm}$, indicating only 1–2 layers of graphene.^{8,19} The AFM image also shows height fluctuations due to wrinkles, which will be discussed later. Figure 2(c) shows representative Raman spectra measured (with a 532 nm excitation laser) from several different locations in a typical transferred GTF. The spectra 1–4 (from top to bottom, offset for clarity) are displayed in the order of decreasing intensity ratio of the “2D” band ($\sim 2700 \text{ cm}^{-1}$) to “G” band ($\sim 1580 \text{ cm}^{-1}$), corresponding to increasing thickness (number of layers) at the locations measured. In particular, the spectrum no. 1 has a 2D/G intensity ratio ~ 2 , likely corresponding to only 1–2 layers of graphene.^{7–12,20–22} Compared to graphene exfoliated on SiO_2 ,^{20–22} it can be more difficult to determine the exact layer thickness of our samples from the Raman spectrum due to possible stacking disorder in the first few layers of CVD grown graphene.^{8–11} The intensity of the disorder-induced “D” band ($\sim 1350 \text{ cm}^{-1}$) in our transferred GTF samples is typically no more than $\sim 10\%$ of the G band intensity, indicative of good crystalline quality.^{7–10,20–22} Figures 2(d) and 2(e) show the XTEM images of thick and thin regions in transferred GTF. Such XTEM analysis can provide the most unambiguous determination of any layer thickness by directly counting the graphene layers. It is, however, partially disruptive to the samples and must be performed with care (see Appendix). The thick region in (d) contains many graphene layers, which show good structural quality (even after the partially disruptive TEM processes) and are parallel to the SiO_2 substrate underneath the transferred GTF. The thin region shown in (e) contains less than six graphene layers. The substantial amount of defects seen are believed to result from the ion beam induced damage inflicted on these relatively vulnerable few graphene layers, and do not necessarily reflect the quality of the GTF before being subject to the partially destructive processes in preparing and imaging TEM cross sections (see Appendix). Figure 2(f) shows a high-resolution scanning tunneling microscopy (STM) image of a transferred GTF. The hexagonal pattern of the underlying graphitic lattice is clearly revealed, down to atomic resolution. Such images can contain valuable information about atomic-scale roughness and defects (for example, adsorbents and vacancies²³) and lattice distortions in the graphene layers.

Wrinkles are often dominant topography features on graphitic films segregated on Ni.^{11,12} The larger wrinkles in our samples can be visible even in optical microscope images [Fig. 1(c)]. Figure 3(a) is a lower resolution STM image of a transferred GTF, showing such wrinkles as tall ridges (height $\sim 60\text{--}100 \text{ nm}$) separating micrometer-scale, relatively flat regions. Although some wrinkles are introduced during the

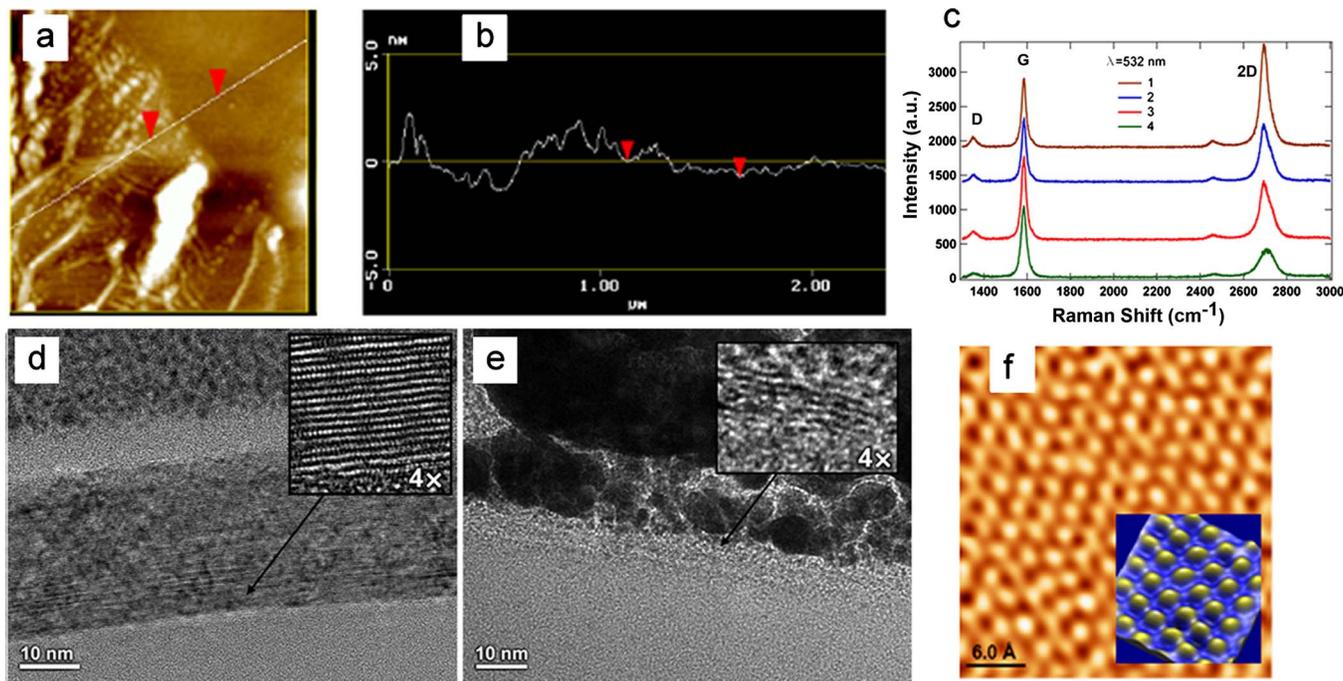


FIG. 2. (Color online) Characterizations of synthesized GTF transferred on SiO₂/Si. (a) AFM image near the edge of a transferred GTF. (b) Cross-sectional height profile corresponding to the line in (a). The step from the SiO₂ surface to GTF has a height of ~ 1 nm, indicating only 1–2 layers of graphene in this region. (c) Raman spectra (offset for clarity) measured from 4 different locations (with different thickness) on a typical transferred GTF. The spectra were measured with a 532 nm excitation laser and a 100 \times objective lens. [(d), (e)] XTEM images of thick (d) and thin (e) regions. The thin layer between the graphene layers and the Pt protective layer (see Appendix) is likely residual photoresist from sample fabrication. The insets show magnified views near the regions indicated by the arrows. The thinner region in (e) was imaged at a lower voltage (80 kV, thus the slightly reduced image quality) than that (300 kV) used in (d) to help prevent electron beam induced damage. A substantial amount of defects seen in these few layers could result from the ion beam induced damage from the partially destructive processes in preparing and imaging TEM cross sections (see Appendix). (f) High resolution STM image in a relatively flat region, revealing the underlying hexagonal graphitic lattice structure. The image mainly resolves atoms from only one sublattice due to the stacking order of graphene layers in graphite (multiplayer graphene) (Ref. 23). A wavelet-based filter is used to enhance the contrast of atomic images. Inset shows a 1.25×1.25 nm² region in magnified three-dimensional view.

transfer process, many of them are already present before the transfer, as shown in the AFM image [Fig. 3(b)] of an as-grown film on a Ni substrate. The height of some of the larger wrinkles can reach ~ 100 nm [inset of Fig. 3(b)], much larger than those of the thickness fluctuations in the graphene layers or the substrate roughness of the Ni. The

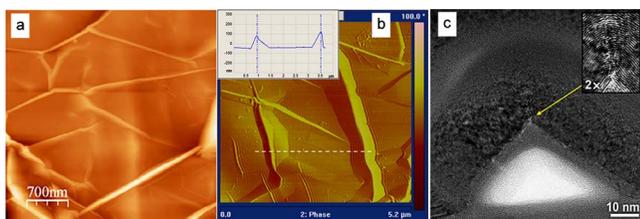


FIG. 3. (Color online) Characterizations of wrinkles. (a) Low resolution STM image of a transferred GTF, with relatively flat domains separated by tall ridges/wrinkles (tens of nm in height). (b) AFM image (phase contrast) of an as-grown film on Ni (before transferring), showing the topography of the wrinkles/ridges on the “crumpled” film. Inset shows cross-sectional height profile corresponding to the dashed line in (c) through two large wrinkles. (c) Cross-sectional image of a wrinkle on a transferred film, taken by TEM. Other disorder features, especially those in the top layers, may be related to beam induced damages from TEM processes and wrinkles along the imaging direction (see Appendix). The film is covered by a thin photoresist and protective amorphous Pt layer. The bright triangular area is due to the void between the wrinkle and the SiO₂. Arrow (yellow, color online) indicates the atomically sharp bending of the wrinkle, with an apparent dislocation line (pointing upward) originated from the bend. The sharp bend is magnified in the inset.

wrinkles also appear to be sharply bent, analogous to folded paper. Figure 3(c) shows a TEM image of the cross section of an isolated wrinkle on a transferred GTF. The wrinkle is seen to display a *sharp*, $\sim 90^\circ$ bend, accompanied by an apparent dislocation line originating from the bend. We have studied a number of such wrinkles in relatively thick regions (containing tens of graphene layers) of both transferred and as-grown films, and have observed qualitatively similar features from all of them. The formation of such wrinkles have been suggested as a mechanism of strain relaxation^{11,12} caused by the coefficient of thermal expansion mismatch between Ni ($\alpha = 12.9\text{--}21.0 \times 10^{-6} \text{ K}^{-1}$) (Ref. 24) and graphene ($0.7\text{--}1.2 \times 10^{-6} \text{ K}^{-1}$) (Ref. 25) during cooldown. For example, the wrinkles could form when graphene layers nucleated from different regions of the Ni coalesce and delaminate from the *contracting* substrate during the cooling-induced segregation process. Defects in the graphene layers may also constitute local weak spots aiding the formation of wrinkles and dislocations. Previous studies,^{11,12} however, have not revealed the atomically sharp bending and dislocations seen in our high-resolution XTEM imaging. Such a microstructure analysis of the wrinkles provides valuable insights on the growth and buckling processes of the GTF. We note that wrinkles formed by similar mechanisms of thermal expansion mismatch are also commonly seen on graphitic films grown on other solid substrates, such as those by sublimation

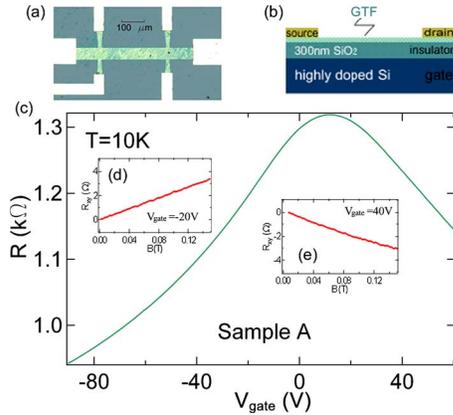


FIG. 4. (Color online) Electronic devices and ambipolar field effect. (a) Optical microscope image of a typical field effect transistor (FET) device (top view) fabricated from a large-scale transferred film, patterned into the Hall bar shape by photolithography. (b) Schematic diagram (not to scale) of the cross section of a FET device. (c) Four-terminal resistance as a function of back gate voltage (V_{gate}), showing the electric field effect. (d) Hall effect (Hall resistance as a function of perpendicular magnetic field) measured at $V_{\text{gate}} = -20$ V, showing a positive sign and predominantly p-type carriers. (e) Hall effect measured at $V_{\text{gate}} = 40$ V, showing a negative sign and predominantly n-type carriers. Data in (c), (d), and (e) are measured in the same sample (A) at a temperature of 10 K. The extracted mobilities for the majority carriers reach ~ 2000 $\text{cm}^2/\text{V s}$.

of SiC.²⁶ Studies of thin film buckling and bending have received great attention in recent years, motivated both by practical applications (for example in integrated circuits and flexible electronics) (Refs. 27 and 28) of thin film materials and fundamental interest (for example, membrane mechanics).²⁹ Smooth and nm-sized ripples (instead of sharply-bent buckles) have been expected and observed in mesoscopic (micrometer sized) single or bilayer graphene and shown to be essential for the stability of such two-dimensional (2D) crystals.^{30,31} On the other hand, the large, sharp wrinkles we have observed may be characteristic of large-scale and/or thicker films and important for the stretchability and mechanical stability of such films for applications such as flexible electronics.⁹

To characterize the electronic properties of the transferred GTF, we have patterned them into relatively large-sized Hall-bars with multiple contact electrodes (Cr/Au). The devices are fabricated by standard optical lithography, plasma etching, and metal deposition. An optical microscope image of a typical device is shown in Fig. 4(a), and the schematic cross section in Fig. 4(b). We have mainly performed two types of electronic measurements at various temperatures: (1) field effect (transistor) measurements, where the heavily doped Si wafer is used as the back gate and (2) magnetotransport measurements, where a perpendicular magnetic field is applied to the film.

Figure 4(c) shows a 4-terminal resistance measured in a device (A) at low temperature ($T=10$ K), where the back gate voltage (V_{gate}) is varied between -90 and 60 V. An ambipolar field effect is evident, where the resistance can be modulated by more than 50%, with its peak (charge-neutral point) occurring at ~ 10 V. Similar field effects are observable up to room temperature, though at low T , a larger range of V_{gate} can be accessed without gate leakage. The insets

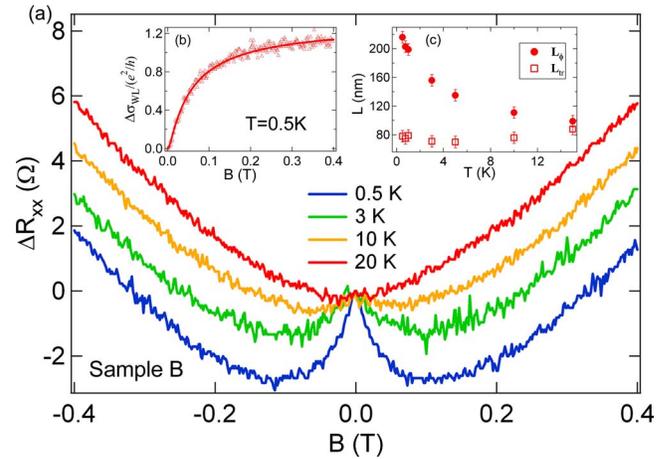


FIG. 5. (Color online) Quantum transport and WL. (a) Magnetoresistance $\Delta R_{xx}(B) = R_{xx}(B) - R_{xx}(0 \text{ T})$ at several temperatures. R_{xx} is the four-terminal (longitudinal) resistance. (b) Magnetoconductivity (normalized by e^2/h) $\Delta\sigma(B) = \sigma(B) - \sigma(0 \text{ T})$ at 0.5 K. Empty circles are measured data (after subtracting a high temperature background to extract the WL correction). Solid line is the fit using the 2D WL theory (Ref. 38) (see text). (c) Extracted phase coherence length (filled circles) and transport scattering length (empty squares) as a function of the temperature.

[Figs. 4(d) and 4(e)] show Hall effects measured at $V_{\text{gate}} = -20$ and 40 V, respectively, with opposite signs of Hall slope observed. Such a sign change in the Hall effect directly shows that our film can be electrically doped from p-type [Fig. 4(d)] to n-type [Fig. 4(e)]. The extracted carrier mobility for V_{gate} far away from the charge-neutral point is ~ 2000 $\text{cm}^2/\text{V s}$. We note that despite the macroscopic size of our sample (with significant thickness nonuniformity and many wrinkles), its mobility is not much lower than those of typical exfoliated^{19,32} (uniform in thickness) and CVD-grown^{8,9} few-layer graphene flakes of much smaller size and less roughness. We also note that the ambipolar field effect we observed are similar to those previously observed in ultrathin 2D graphitic systems (where electronic transport in the field effect is believed to be dominated by only few graphene layers^{19,33,34}), and are likely controlled mostly by the thin regions of our samples. Such an ambipolar field effect are important for various rf/high frequency electronic applications.^{35–37} It has also been pointed out that for rf devices, even moderate mobilities and field effect “on/off” modulation ratio such as those observed in our samples ($\sim 50\%$) can already be quite valuable.^{35,36}

Figure 5(a) shows the magnetoresistance $\Delta R_{xx}(B) = R_{xx}(B) - R_{xx}(B=0 \text{ T})$ measured between -0.4 and 0.4 T in a device (B) at several temperatures. At low temperature (e.g., $T=0.5$ K), we observe a pronounced low field negative magnetoresistance (with a peak in R_{xx} at $B=0$ T), which weakens at elevated temperatures and disappears at sufficiently high T ($> \sim 20$ K). Such features are characteristic of so called WL,³⁸ and have been observed in many other graphitic systems.^{2,32,39–44}

WL arises from the constructive quantum interference between time-reversed multiple-scattering trajectories (within a length scale L_ϕ that the electron wave function is phase coherent) that enhances the probability of electron localization (and thus also the electrical resistance). Such a WL

can be destroyed by a magnetic field (which breaks the time-reversal symmetry) or by high temperature, giving rise to the observed negative magnetoresistance at low T . We found that our data can be well described by the standard WL theory for a 2D diffusive metal³⁸ (see Appendix). Excellent fit (an example is shown in inset 5b) has been obtained for the entire range of measured data for all temperatures at which WL has been observed, using L_φ (the afore-mentioned phase coherence length) and L_{tr} (the transport scattering length) as two fitting parameters. Inset 5c shows L_φ and L_{tr} thus extracted and plotted as a function of the temperature. L_{tr} is found to be largely temperature insensitive in the measured range and its value is on the same order of magnitude as the transport mean-free path (~ 30 – 60 nm) extracted from the mobilities. The phase coherence length L_φ steadily rises as T is lowered, reaching above $0.2 \mu\text{m}$ at low T (0.5 K). The L_φ is much smaller than the size (hundreds of micrometer) of our devices, consistent with the diffusive³⁸ limit of the electronic transport. On the other hand, we envision that phase coherent or ballistic transport may be explored in much smaller sub-micron devices fabricated from our CVD-grown GTF. This may lead to novel quantum devices,^{45,46} where phase coherent electron transport is utilized for new device functionalities or improved performance.

WL has received strong attention in recent studies of both exfoliated^{32,40–43} and epitaxially grown (on SiC) (Refs. 2 and 44) graphene systems. A host of important information valuable to develop and improve graphene-based electronics, including information about the scattering and quantum transport of carriers, as well as the disorder in the samples, can be obtained by careful analysis of magnetotransport behavior such as WL. In our case, the atomic-scale defects that we imaged, such as the atomically sharp bending and dislocation associated with the wrinkles, could be part of the disorder that results in WL. On the other hand, the presence of nonuniformity and roughness (many wrinkles) in our large sized samples does *not* appear to be detrimental for the device performance, gauged by, for example the field effect and mobility (comparing to smaller samples with less roughness). The wrinkles have in fact been suggested to be beneficial for the mechanical flexibility⁹ of the large-size film.

Much of the active research concerning graphene is inspired by the remarkable properties discovered in *uniform* few-layer (especially monolayer) graphene,¹ leading to a focus on the growth of large-scale graphene with *uniform* thickness. This is undoubtedly a noble goal, with rapid advances made recently.^{47,48} On the other hand, many of the existing graphene production methods (including numerous low-cost, solution-based chemical approaches^{3,13–16}) yield large but *nonuniform* films consisting of an electrically connected mixture of both thick and thin regions, as is the case with the GTF grown and transferred from Ni studied here. Besides interesting structural and mechanical properties of such large-scale films, we have demonstrated a number of electronic properties previously studied in uniform few-layer graphene and promising for various device applications. These include the ambipolar field effect with high carrier mobility and quasi-2D transport with quantum coherence. The fact that these promising electronic properties can still

be observed in such films despite their nonuniformity, and thus are not restricted to uniform few-layer graphene, can be important for employing various graphene-based materials produced by diverse methods in practical applications ranging from thin film transistors, high speed/high frequency devices^{35,36} to conductive coatings, transparent electrodes,⁴⁹ or flexible electronics.⁹

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APPENDIX

1. Synthesis and transfer of graphene layers

The procedures used to synthesize graphene layers on Ni substrates are detailed in Ref. 7, which also demonstrated a different method from what is used in this work to transfer the GTF onto other substrates. Briefly, we dissolve carbon (decomposed from precursor gases containing hydrocarbon, such as CH_4) into bulk Ni (serving also as a catalyst) foils at ~ 1000 °C, followed by cooling using a carefully chosen rate⁷ (~ 10 °C/s) to room temperature. During the cooldown, the solubility of carbon in Ni decreases and carbon segregates at the surface of the Ni substrate to form graphene layers. Afterwards the Ni substrate with the synthesized GTF (usually scratched slightly to aid its removal) is soaked in high concentration HNO_3 solution. After a few minutes, the film detaches from the substrate and floats on the acid surface, and is ready to be transferred.

2. AFM, STM, and TEM measurements

AFM (Nanoscope IIIa, Digital Instruments) topography images (height and phase contrast) are taken with the tapping mode under ambient conditions. STM images are taken under ambient conditions by a Nanotech Electronica's Dulcinea Scanning Probe Microscopy (SPM) system, whose head is housed in a Faraday Cage in a low noise room. The GTF transferred to Si/SiO₂ is connected with thin Cu tapes to provide a conducting path in STM measurements. Graphitic lattices [Fig. 2(f)] are imaged in the relative flat regions (away from wrinkles) of the sample. The STM images are analyzed using WSXM software version 13.0 and a wavelet-based filter⁵⁰ is used to enhance the contrast of atomic images. The atomic images of highly oriented pyrolytic graph-

ite are used to calibrate the X-Y piezo. TEM cross sections (~ 100 nm wide along the imaging direction) were prepared by a focused ion beam liftout method, with an initial protective layer deposited from a platinum source under the electron beam. An FEI Titan 80–300 TEM operating at either 300 keV [Figs. 2(d) and 3(c)] or 80 keV [Fig. 2(e)] was used to examine the cross sections. Images were recorded through a Gatan imaging filter, and typically zero loss filtered with a 10 eV window to improve clarity and contrast. The magnified insets in Fig. 2(d) has been processed using a rolling ball background subtraction filter.⁵¹ The 300 keV imaging electron beam and the process used to prepare the cross section are partially disruptive to the sample (especially for the top graphene layers), making it particularly challenging to study thinner regions (< 10 layers) and contributing to the defective features often seen in the top layers of the XTEM images [Figs. 2(d) and 3(c)]. Using lower voltage (80 keV) imaging beam can help prevent electron beam induced damage at the cost of lower image quality. Interpreting the images of the top graphene layers can also be complicated by the significant out of plane fluctuations (wrinkles) along the line-of-sight of the imaging beam. The sharpness of the wrinkle features [Fig. 3(c)] is found to be similar in multiple samples and also decrease with prolonged TEM exposure, suggesting that the features are likely intrinsic to the sample rather than artifacts created by TEM.

3. Electronic transport measurements and WL analysis

Electronic transport measurements are performed in a variable temperature insert (Scientific Magnetics) and a He-3 system (Janis), using standard low frequency (~ 10 Hz) lock-in (SRS) detection, with typical excitation current of 100 nA. The WL correction in the low temperature magnetoconductivity (Fig. 5) $\Delta\sigma(B) = \sigma(B) - \sigma(B=0 \text{ T})$ is fitted to the theoretically predicted form (Ref. 38) for 2D diffusive metals, $\Delta\sigma_{\text{WL}}(B) = [(2e^2/\pi h)] \{ F[\{8\pi B/(h/e)L_\phi^{-2}\}] - F[\{8\pi B/(h/e)L_{\text{tr}}^{-2}\}] \}$, where e is electron charge, h is the Planck constant, and $F[z] = \ln(z) + \Psi(1/2 + 1/z)$ with Ψ being the Digamma function. L_ϕ (phase coherence length) and L_{tr} (transport scattering length) are two fitting parameters.

¹A. K. Geim and K. S. Novoselov, *Nature Mater.* **6**, 183 (2007).

²W. A. de Heer, C. Berger, X. Wu, P. N. First, E. H. Conrad, X. Li, T. Li, M. Sprinkle, J. Hass, M. L. Sadowski, M. Potemski, and G. Martinez, *Solid State Commun.* **143**, 92 (2007).

³S. Park and R. S. Ruoff, *Nat. Nanotechnol.* **4**, 217 (2009).

⁴A. N. Obraztsov, *Nat. Nanotechnol.* **4**, 212 (2009).

⁵C. Oshima and A. Nagashima, *J. Phys.: Condens. Matter* **9**, 1 (1997).

⁶A. E. Karu and M. Beer, *J. Appl. Phys.* **37**, 2179 (1966).

⁷Q. K. Yu, J. Lian, S. Siripongert, H. Li, Y. P. Chen, and S. S. Pei, *Appl. Phys. Lett.* **93**, 113103 (2008).

⁸A. Reina, X. Jia, J. Ho, D. Nezich, H. Son, V. Bulovic, M. S. Dresselhaus, and J. Kong, *Nano Lett.* **9**, 30 (2009).

⁹K. S. Kim, Y. Zhao, H. Jang, S. Y. Lee, J. M. Kim, K. S. Kim, J. H. Ahn, P. Kim, J. Y. Choi, and B. H. Hong, *Nature (London)* **457**, 706 (2009).

¹⁰L. G. De Arco, Y. Zhang, A. Kumar, and C. Zhou, *IEEE Trans. Nanotechnol.* **8**, 135 (2009).

¹¹S. J. Chae, F. Gunes, K. K. Kim, E. S. Kim, G. H. Han, S. M. Kim, H. J. Shin, S. M. Yoon, J. Y. Choi, M. H. Park, C. W. Yang, D. Pribat, and Y. H. Lee, *Adv. Mater. (Weinheim, Ger.)* **21**, 2328 (2009).

¹²A. N. Obraztsov, E. A. Obraztsova, A. V. Tyurnina, and A. A. Zolotukhin, *Carbon* **45**, 2017 (2007).

¹³S. Gilje, S. Han, M. Wang, K. L. Wang, and R. B. Kaner, *Nano Lett.* **7**, 3394 (2007).

¹⁴C. Gómez-Navarro, R. T. Weitz, A. M. Bittner, M. Scolari, A. Mews, M. Burghard, and K. Kern, *Nano Lett.* **7**, 3499 (2007).

¹⁵L. J. Cote, F. Kim, and J. Huang, *J. Am. Chem. Soc.* **131**, 1043 (2009).

¹⁶D. A. Dikin, S. Stankovich, E. J. Zimney, R. D. Piner, G. H. B. Dommett, G. Evmenenko, S. T. Nguyen, and R. S. Ruoff, *Nature (London)* **448**, 457 (2007).

¹⁷P. Blake, E. W. Hill, A. H. C. Neto, K. S. Novoselov, D. Jiang, R. Yang, T. J. Booth, and A. K. Geim, *Appl. Phys. Lett.* **91**, 063124 (2007).

¹⁸Z. H. Ni, H. M. Wang, J. Kasim, H. M. Fan, T. Yu, Y. H. Wu, Y. P. Feng, and Z. X. Shen, *Nano Lett.* **7**, 2758 (2007).

¹⁹K. S. Novoselov, A. K. Geim, S. V. Morozov, D. Jiang, Y. Zhang, S. V. Dubonos, I. V. Grigorieva, and A. A. Firsov, *Science* **306**, 666 (2004).

²⁰A. C. Ferrari, J. C. Meyer, V. Scardaci, C. Casiraghi, M. Lazzeri, F. Mauri, S. Piscanec, D. Jiang, K. S. Novoselov, S. Roth, and A. K. Geim, *Phys. Rev. Lett.* **97**, 187401 (2006).

²¹A. Gupta, G. Chen, P. Joshi, S. Tadigadapa, and P. C. Eklund, *Nano Lett.* **6**, 2667 (2006).

²²D. Graf, F. Molitor, K. Ensslin, C. Stampfer, A. Jungen, C. Hierold, and L. Wirtz, *Nano Lett.* **7**, 238 (2007).

²³J. C. Meyer, C. Kisielowski, R. Ermi, M. D. Rossell, M. F. Crommie, and A. Zettl, *Nano Lett.* **8**, 3582 (2008).

²⁴T. G. Kollie, *Phys. Rev. B* **16**, 4872 (1977).

²⁵H. O. Pierson, *Handbook of Carbon, Graphite, Diamond and Fullerenes—Properties, Processing and Applications* (Noyes Publications, Park Ridge, New Jersey, 1993).

²⁶Z. G. Cambaz, G. Yushin, S. Osswald, V. Mochalin, and Y. Goyotsi, *Carbon* **46**, 841 (2008).

²⁷L. B. Freund and S. Suresh, *Thin Film Materials: Stress, Defect Formation, and Surface Evolution* (Cambridge University Press, Cambridge, 2003).

²⁸D. H. Kim, J. H. Ahn, W. M. Choi, H. S. Kim, T. H. Kim, J. Song, Y. Y. Huang, Z. Liu, C. Lu, and J. A. Rogers, *Science* **320**, 507 (2008).

²⁹D. R. Nelson, T. Piran, and S. Weinberg, *Statistical Mechanics of Membranes and Surfaces* (World Scientific, Singapore, 2004).

³⁰J. C. Meyer, A. K. Geim, M. I. Katsnelson, K. S. Novoselov, T. J. Booth, and S. Roth, *Nature (London)* **446**, 60 (2007).

³¹A. Fasolino, J. H. Los, and M. I. Katsnelson, *Nature Mater.* **6**, 858 (2007).

³²F. V. Tikhonenko, D. W. Horsell, R. V. Gorbachev, and A. K. Savchenko, *Phys. Rev. Lett.* **100**, 056802 (2008).

³³Y. Zhang, J. P. Small, M. E. S. Amori, and P. Kim, *Phys. Rev. Lett.* **94**, 176803 (2005).

³⁴S. V. Morozov, K. S. Novoselov, F. Schedin, D. Jiang, A. A. Firsov, and A. K. Geim, *Phys. Rev. B* **72**, 201401 (2005).

³⁵Y. M. Lin, K. A. Jenkins, A. Valdes-Garcia, J. P. Small, D. B. Farmer, and P. Avouris, *Nano Lett.* **9**, 422 (2009).

³⁶I. Meric, M. Y. Han, A. F. Young, B. Ozyilmaz, P. Kim, and K. L. Shepard, *Nat. Nanotechnol.* **3**, 654 (2008).

³⁷H. Wang, D. Nezich, J. Kong, and T. Palacios, *IEEE Electron Device Lett.* **5**, 547 (2008).

³⁸C. W. J. Beenakker and H. van Houten, in *Solid State Physics*, edited by H. Ehrenreich and D. Turnbull (Academic, San Diego, 1991), Vol. 44, Chap. 1.

³⁹Y. Koike, S. Morita, T. Nakanomyo, and T. Fukase, *J. Phys. Soc. Jpn.* **54**, 713 (1985).

⁴⁰S. V. Morozov, K. S. Novoselov, M. I. Katsnelson, F. Schedin, L. A. Ponomarenko, D. Jiang, and A. K. Geim, *Phys. Rev. Lett.* **97**, 016801 (2006).

⁴¹X. Wu, X. Li, Z. Song, C. Berger, and W. A. de Heer, *Phys. Rev. Lett.* **98**, 136801 (2007).

⁴²R. V. Gorbachev, F. V. Tikhonenko, A. S. Mayorov, D. W. Horsell, and A. K. Savchenko, *Phys. Rev. Lett.* **98**, 176805 (2007).

⁴³D. Ki, D. Jeong, J. Choi, H. Lee, and K. Park, *Phys. Rev. B* **78**, 125409 (2008).

⁴⁴T. Shen, Y. Q. Wu, M. A. Capano, L. P. Rokhinson, L. W. Engel, and P. D. Ye, *Appl. Phys. Lett.* **93**, 122102 (2008).

⁴⁵M. J. Kelly, *Low-Dimensional Semiconductors: Materials, Physics, Technology, Devices* (Oxford University Press, Oxford, 1996).

⁴⁶S. Datta, *Electronic Transport in Mesoscopic Systems* (Cambridge University Press, Cambridge, 1997).

⁴⁷K. V. Emtsev, A. Bostwick, K. Horn, J. Jobst, G. L. Kellogg, L. Ley, J. L. McChesney, T. Ohta, S. A. Reshanov, J. Röhrl, E. Rotenberg, A. K.

- Schmid, D. Waldmann, H. B. Weber, and T. Seyller, *Nature Mater.* **8**, 203 (2009).
- ⁴⁸X. Li, W. Cai, J. An, S. Kim, J. Nah, D. Yang, R. Piner, A. Velamakanni, I. Jung, E. Tutuc, S. K. Banerjee, L. Colombo, and R. S. Ruoff, *Science* **324**, 1312 (2009).
- ⁴⁹X. Wang, L. Zhi, and K. Müllen, *Nano Lett.* **8**, 323 (2008).
- ⁵⁰C. Gackenheimer, L. Cayon, and R. Relfenberger, *Ultramicroscopy* **106**, 389 (2006).
- ⁵¹W. S. Rasband and J. Image, U. S. National Institutes of Health, Bethesda, Maryland, USA, 1997–2009, <http://rsb.info.nih.gov/ij/>